



Final data

SPW11N60C2

Cool MOS™ Power Transistor

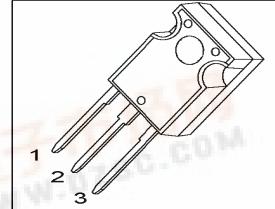
Feature

- New revolutionary high voltage technology
- Ultra low gate charge
- Periodic avalanche rated
- Extreme dv/dt rated
- Ultra low effective capacitances
- Improved noise immunity

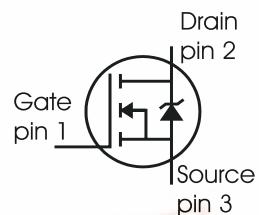
Product Summary

| | | |
|--------------|------|----------|
| V_{DS} | 600 | V |
| $R_{DS(on)}$ | 0.38 | Ω |
| I_D | 11 | A |

P-T0247



| Type | Package | Ordering Code | Marking |
|------------|---------|---------------|---------|
| SPW11N60C2 | P-T0247 | Q67040-S4313 | 11N60C2 |



Maximum Ratings, at $T_C = 25^\circ\text{C}$, unless otherwise specified

| Parameter | Symbol | Value | Unit |
|---|----------------|-------------|------|
| Continuous drain current $T_C = 25^\circ\text{C}$ | I_D | 11 | A |
| $T_C = 100^\circ\text{C}$ | | 7 | |
| Pulsed drain current, t_p limited by T_{jmax} | $I_{D\ puls}$ | 22 | |
| Avalanche energy, single pulse $I_D=5.5\text{A}, V_{DD}=50\text{V}$ | E_{AS} | 340 | mJ |
| Avalanche energy, repetitive t_{AR} limited by T_{jmax} ¹⁾ $I_D=11\text{A}, V_{DD}=50\text{V}$ | E_{AR} | 0.6 | |
| Avalanche current, repetitive t_{AR} limited by T_{jmax} | I_{AR} | 11 | A |
| Reverse diode dv/dt $I_S=11\text{A}, V_{DS} < V_{DD}, dI/dt=100\text{A}/\mu\text{s}, T_{jmax}=150^\circ\text{C}$ | dv/dt | 6 | V/ns |
| Gate source voltage | V_{GS} | ± 20 | V |
| Power dissipation, $T_C = 25^\circ\text{C}$ | P_{tot} | 125 | W |
| Operating and storage temperature | T_j, T_{stg} | -55... +150 | °C |

Thermal Characteristics

| Parameter | Symbol | Values | | | Unit |
|-----------|--------|--------|------|------|------|
| | | min. | typ. | max. | |

Characteristics

| | | | | | |
|--|-------------------|---|---|-----|-----|
| Thermal resistance, junction - case | R_{thJC} | - | - | 1 | K/W |
| Thermal resistance, junction - ambient, leaded | R_{thJA} | - | - | 62 | |
| Linear derating factor | | - | - | 1 | W/K |
| Soldering temperature, 1.6 mm (0.063 in.) from case for 10s | T_{sold} | - | - | 260 | °C |

Electrical Characteristics, at $T_j = 25$ °C, unless otherwise specified

| Static Characteristics | | | | | |
|--|----------------------|-----|------|-----------|----|
| Drain-source breakdown voltage $V_{GS}=0V, I_D=0.25mA$ | $V_{(\text{BR})DSS}$ | 600 | - | - | V |
| Drain-source avalanche breakdown voltage $V_{GS}=0V, I_D=11A$ | $V_{(\text{BR})DS}$ | - | 700 | - | |
| Gate threshold voltage, $V_{GS} = V_{DS}$ $I_D=0.5mA$ | $V_{GS(\text{th})}$ | 3.5 | 4.5 | 5.5 | |
| Zero gate voltage drain current $V_{DS} = 600$ V, $V_{GS} = 0$ V, $T_j = 25$ °C $V_{DS} = 600$ V, $V_{GS} = 0$ V, $T_j = 150$ °C | I_{DSS} | - | - | 25 250 | µA |
| Gate-source leakage current $V_{GS}=20V, V_{DS}=0V$ | I_{GSS} | - | - | 100 | nA |
| Drain-source on-state resistance $V_{GS}=10V, I_D=7A, T_j=25^\circ C$ | $R_{DS(\text{on})}$ | - | 0.34 | 0.38 | Ω |
| Gate input resistance $f = 1$ MHz, open drain | R_G | - | 0.86 | - | |

¹ Repetitive avalanche causes additional power losses that can be calculated as $P_{AV}=E_{AR} \cdot f$.

Electrical Characteristics, at $T_j = 25^\circ\text{C}$, unless otherwise specified

| Parameter | Symbol | Conditions | Values | | | Unit |
|---|--------------|---|--------|------|------|------|
| | | | min. | typ. | max. | |
| Characteristics | | | | | | |
| Transconductance | g_{fs} | $V_{DS} \geq 2 * I_D * R_{DS(on)max}$ $I_D = 7\text{A}$ | 3 | 6 | - | S |
| Input capacitance | C_{iss} | $V_{GS}=0\text{V}$, $V_{DS}=25\text{V}$, $f=1\text{MHz}$ | - | 1460 | - | pF |
| Output capacitance | C_{oss} | | - | 610 | - | |
| Reverse transfer capacitance | C_{rss} | | - | 21 | - | |
| Effective output capacitance, ¹⁾ energy related | $C_{o(er)}$ | $V_{GS}=0\text{V}$, $V_{DS}=0\text{V to } 480\text{V}$ | - | 45 | - | pF |
| Effective output capacitance, ²⁾ time related | $C_{o(tr)}$ | | - | 85 | - | |
| Turn-on delay time | $t_{d(on)}$ | $V_{DD}=380\text{V}$, $V_{GS}=0/13\text{V}$, $I_D=11\text{A}$, $R_G=6.8\Omega$, $T_j=125^\circ\text{C}$ | - | 13 | - | ns |
| Rise time | t_r | | - | 40 | - | |
| Turn-off delay time | $t_{d(off)}$ | | - | 48 | 72 | |
| Fall time | t_f | | - | 9 | 13.5 | |

Gate Charge Characteristics

| | | | | | | |
|-----------------------|-----------------|---|---|------|----|----|
| Gate to source charge | Q_{gs} | $V_{DD}=350\text{V}$, $I_D=11\text{A}$ | - | 10.5 | - | nC |
| Gate to drain charge | Q_{gd} | | - | 24 | - | |
| Gate charge total | Q_g | $V_{DD}=350\text{V}$, $I_D=11\text{A}$, $V_{GS}=0$ to 10V | - | 41.5 | 54 | |
| Gate plateau voltage | $V_{(plateau)}$ | $V_{DD}=350\text{V}$, $I_D=11\text{A}$ | - | 8 | - | V |

¹ $C_{o(er)}$ is a fixed capacitance that gives the same stored energy as C_{oss} while V_{DS} is rising from 0 to 80% V_{DSS} .

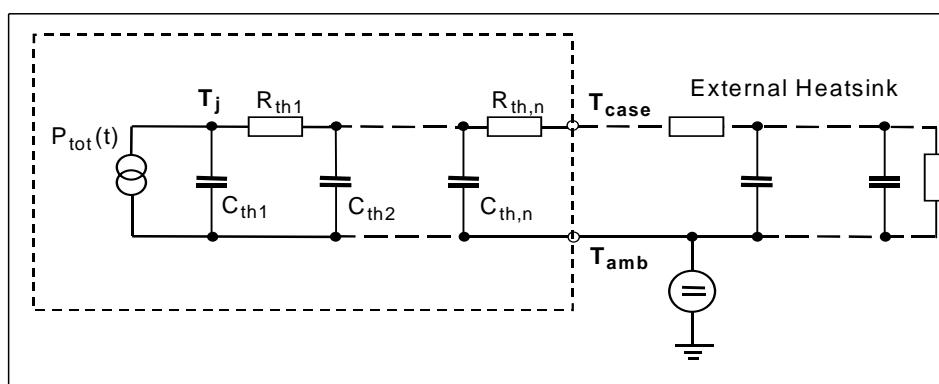
² $C_{o(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 to 80% V_{DSS} .

Electrical Characteristics, at $T_j = 25^\circ\text{C}$, unless otherwise specified

| Parameter | Symbol | Conditions | Values | | | Unit |
|---|--------------|---|--------|------|------|------------------------|
| | | | min. | typ. | max. | |
| Characteristics | | | | | | |
| Inverse diode continuous forward current | I_S | $T_C=25^\circ\text{C}$ | - | - | 11 | A |
| Inverse diode direct current, pulsed | I_{SM} | | - | - | 22 | |
| Inverse diode forward voltage | V_{SD} | $V_{GS}=0\text{V}, I_F=I_S$ | - | 1 | 1.2 | V |
| Reverse recovery time | t_{rr} | $V_R=350\text{V}, I_F=I_S, dI/dt=100\text{A}/\mu\text{s}$ | - | 650 | 1105 | ns |
| Reverse recovery charge | Q_{rr} | | - | 7.9 | - | μC |
| Peak reverse recovery current | I_{rrm} | | - | 30 | - | A |
| Peak rate of fall of reverse recovery current | dI_{rr}/dt | | - | 600 | - | $\text{A}/\mu\text{s}$ |

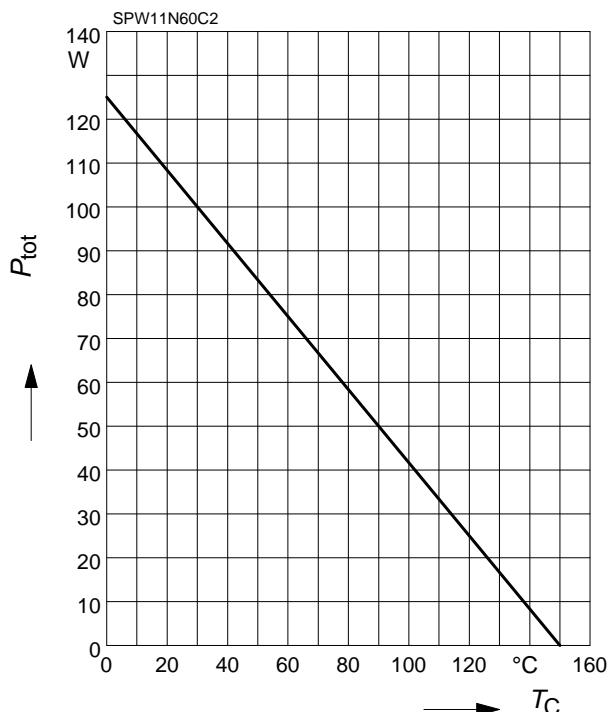
Typical Transient Thermal Characteristics

| Symbol | Value typ. | Unit | Symbol | Value typ. | Unit |
|--------------------|---------------|------|---------------------|---------------|------|
| | | | | | |
| Thermal resistance | | | Thermal capacitance | | |
| R_{th1} | 0.015 | K/W | C_{th1} | 0.0002121 | Ws/K |
| R_{th2} | 0.034 | | C_{th2} | 0.0007091 | |
| R_{th3} | 0.042 | | C_{th3} | 0.001184 | |
| R_{th4} | 0.116 | | C_{th4} | 0.001527 | |
| R_{th5} | 0.149 | | C_{th5} | 0.011 | |
| R_{th6} | 0.059 | | C_{th6} | 0.089 | |



1 Power dissipation

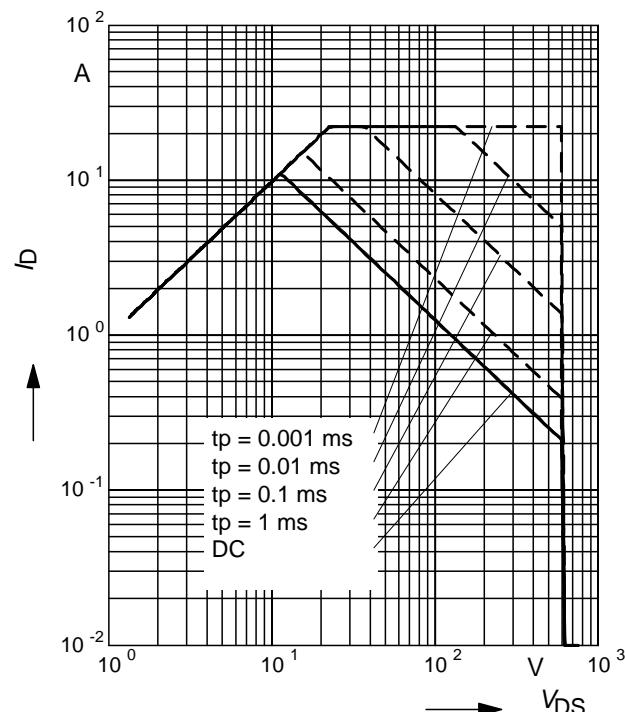
$$P_{\text{tot}} = f(T_C)$$



2 Safe operating area

$$I_D = f(V_{DS})$$

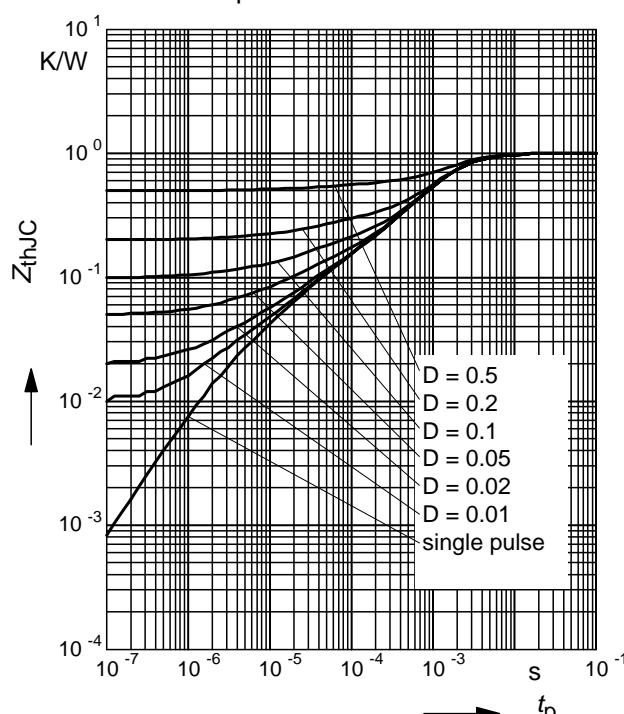
parameter : $D = 0$, $T_C=25^\circ\text{C}$



3 Transient thermal impedance

$$Z_{\text{thJC}} = f(t_p)$$

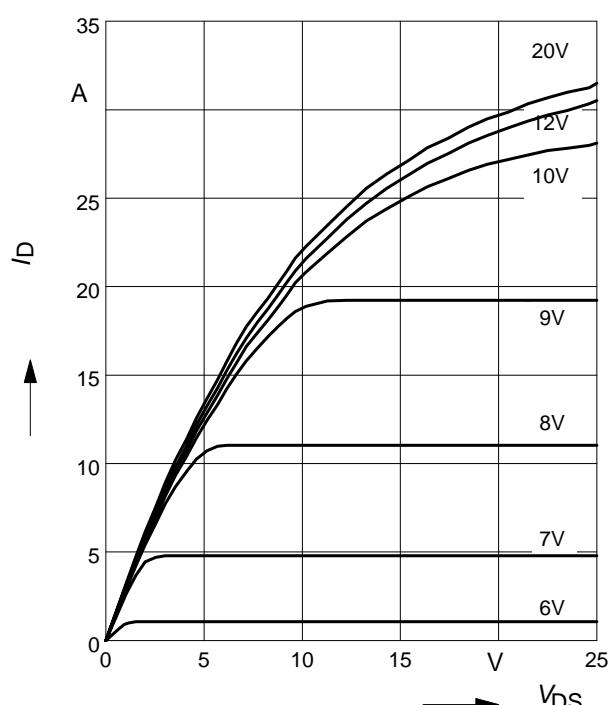
parameter: $D = t_p/T$



4 Typ. output characteristic

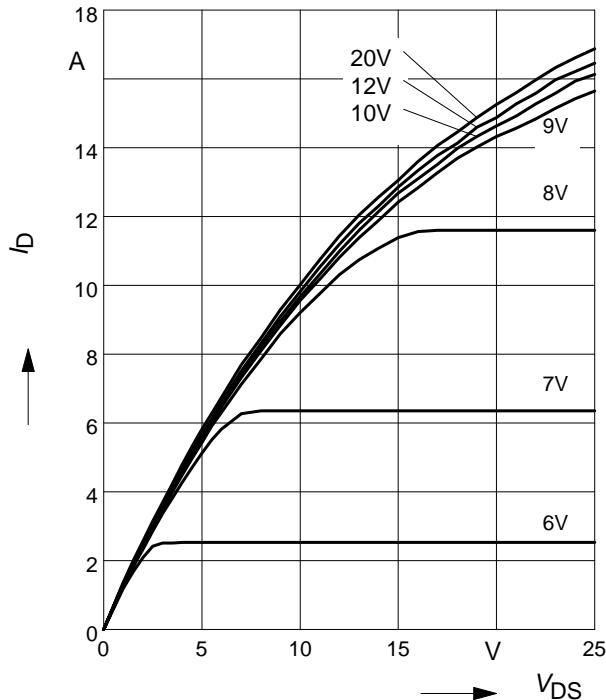
$$I_D = f(V_{DS}); \quad T_j=25^\circ\text{C}$$

parameter: $t_p = 10 \mu\text{s}$, V_{GS}



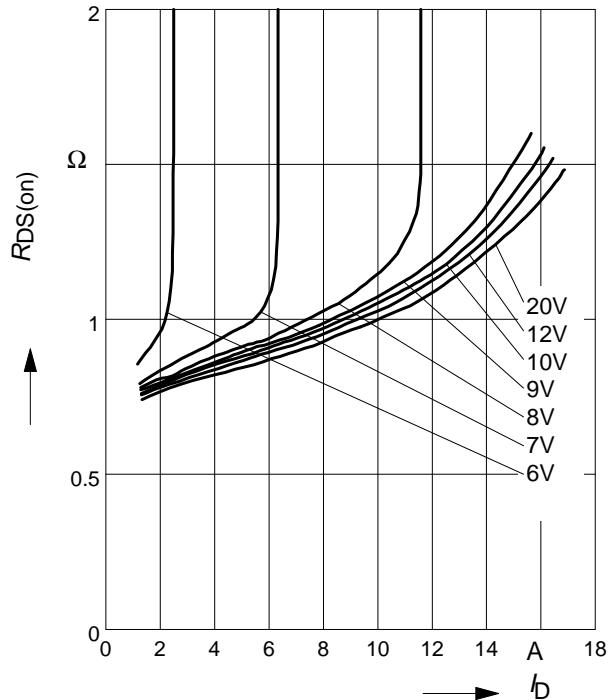
5 Typ. output characteristic

$I_D = f(V_{DS})$; $T_j=150^\circ\text{C}$
parameter: $t_p = 10 \mu\text{s}$, V_{GS}



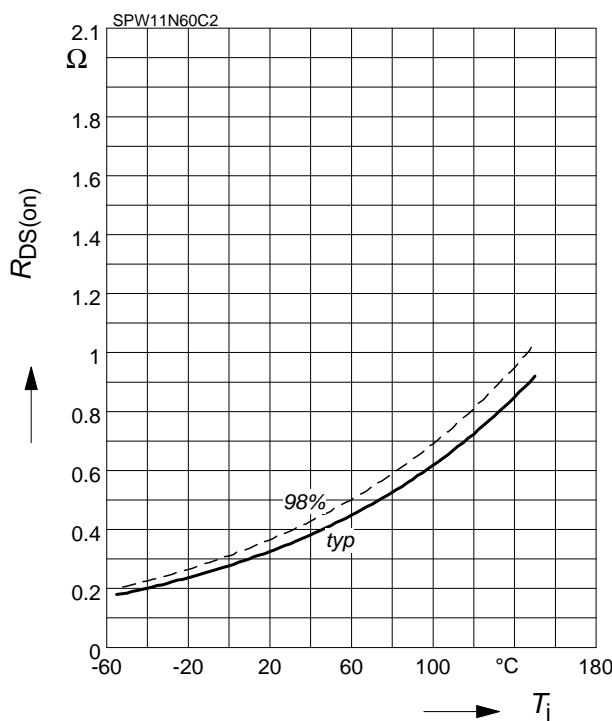
6 Typ. drain-source on resistance

$R_{DS(on)}=f(I_D)$
parameter: $T_j=150^\circ\text{C}$, V_{GS}



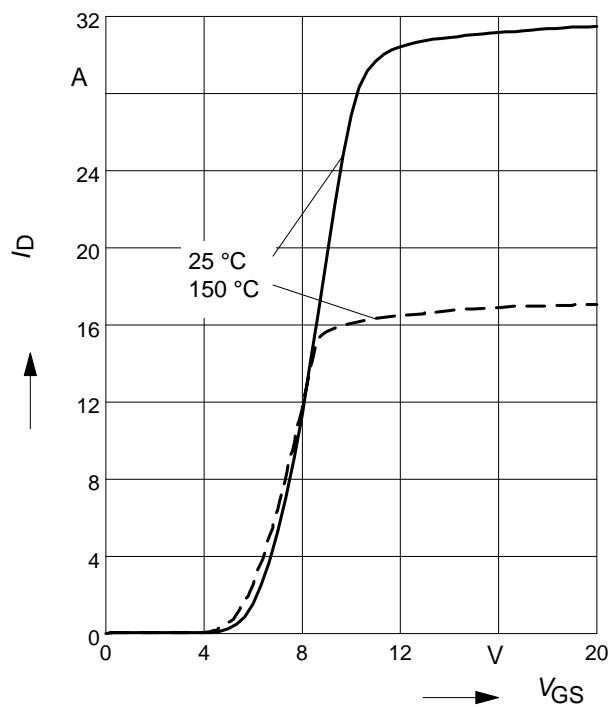
7 Drain-source on-state resistance

$R_{DS(on)} = f(T_j)$
parameter : $I_D = 7 \text{ A}$, $V_{GS} = 10 \text{ V}$



8 Typ. transfer characteristics

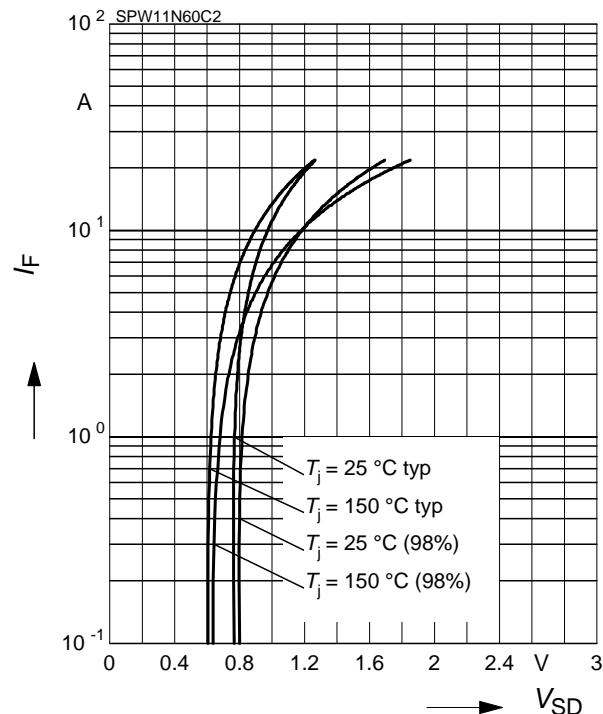
$I_D=f(V_{GS})$; $V_{DS}\geq 2 \times I_D \times R_{DS(\text{on})\max}$
parameter: $t_p = 10 \mu\text{s}$



9 Forward characteristics of body diode

$$I_F = f(V_{SD})$$

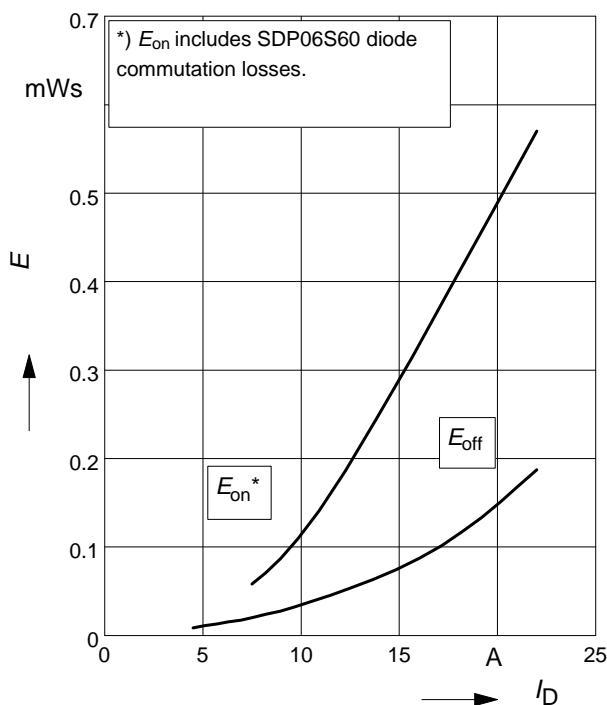
parameter: T_j , $t_p = 10 \mu\text{s}$



11 Typ. switching losses

$$E = f(I_D), \text{ inductive load, } T_j=125^\circ\text{C}$$

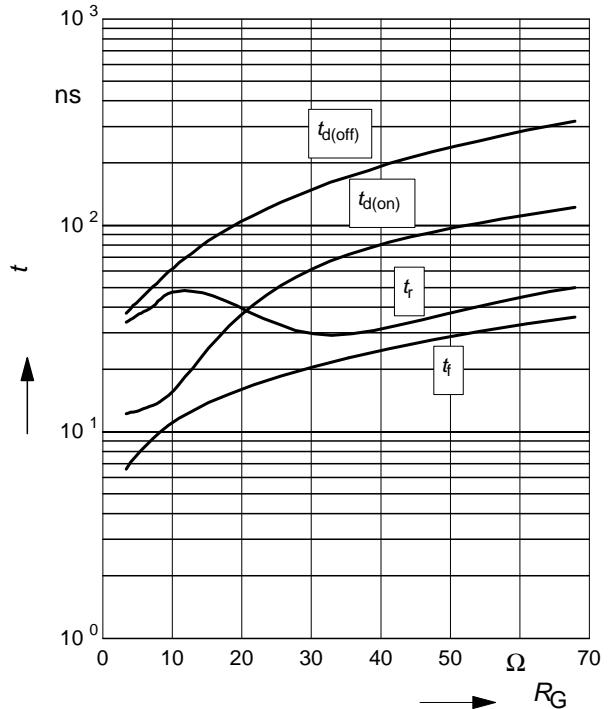
par.: $V_{DS}=380\text{V}$, $V_{GS}=0/+13\text{V}$, $R_G=6.8\Omega$



10 Typ. switching time

$$t = f(R_G), \text{ inductive load, } T_j=125^\circ\text{C}$$

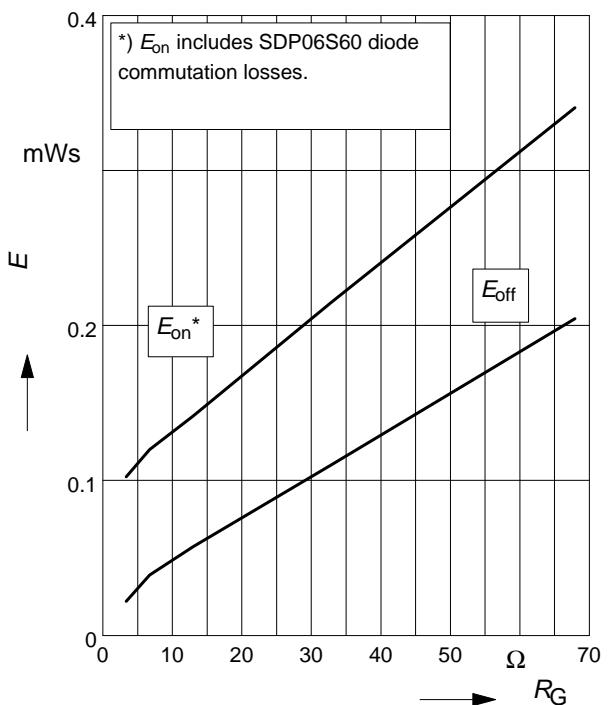
par.: $V_{DS}=380\text{V}$, $V_{GS}=0/+13\text{V}$, $I_D=11\text{A}$



12 Typ. switching losses

$$E = f(R_G), \text{ inductive load, } T_j=125^\circ\text{C}$$

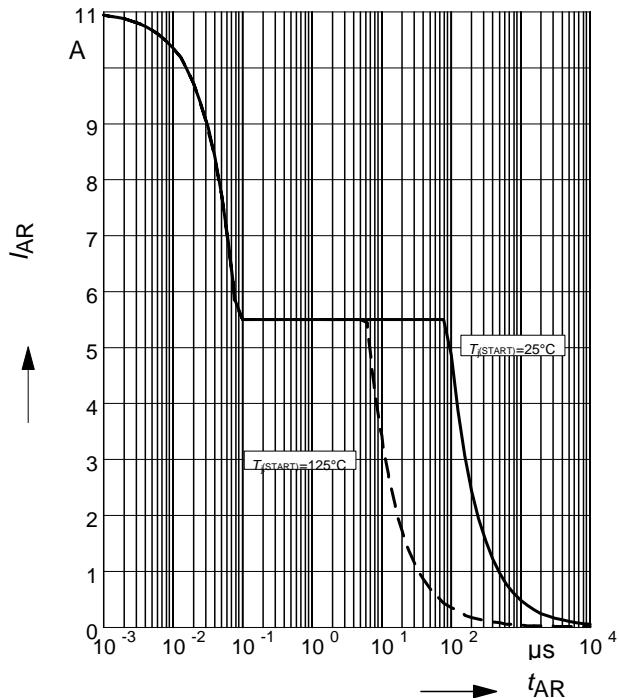
par.: $V_{DS}=380\text{V}$, $V_{GS}=0/+13\text{V}$, $I_D=11\text{A}$



13 Avalanche SOA

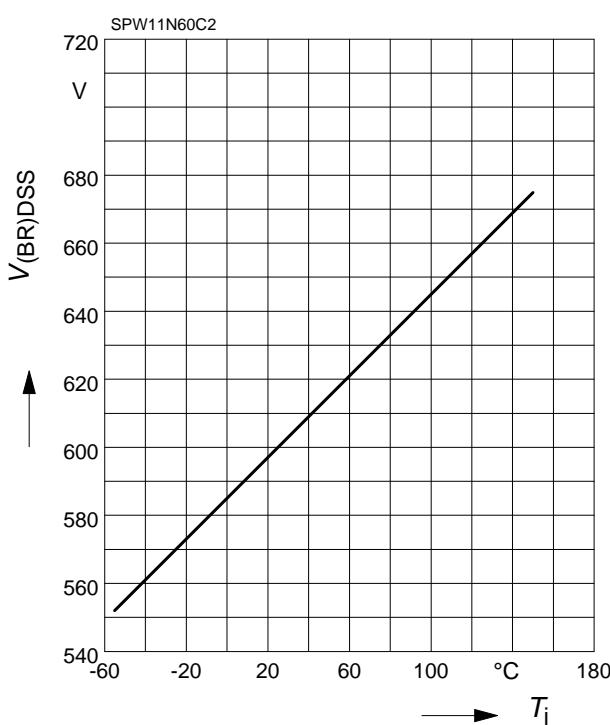
$$I_{AR} = f(t_{AR})$$

par.: $T_j \leq 150^\circ\text{C}$



15 Drain-source breakdown voltage

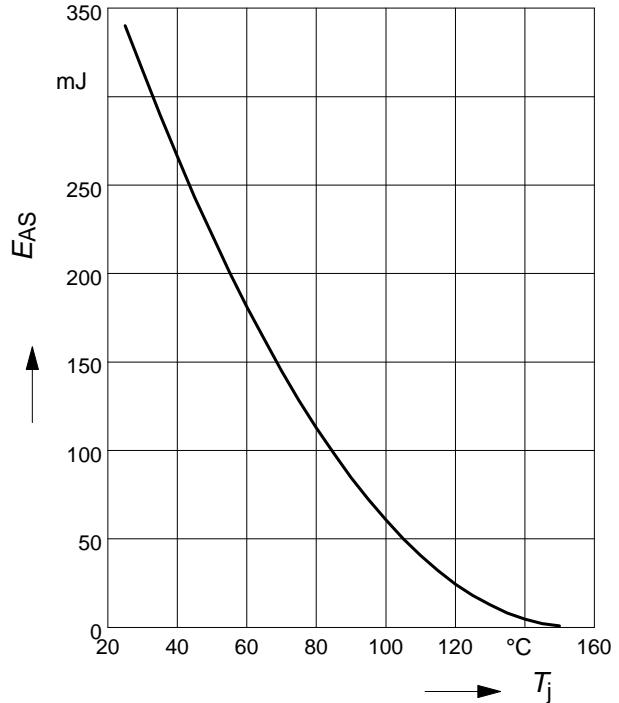
$$V_{(BR)DSS} = f(T_j)$$



14 Avalanche energy

$$E_{AS} = f(T_j)$$

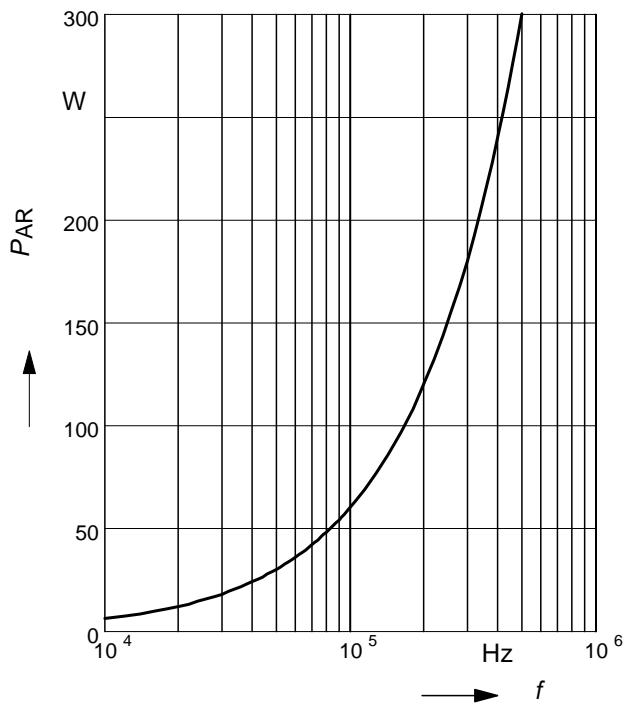
par.: $I_D = 5.5 \text{ A}$, $V_{DD} = 50 \text{ V}$



16 Avalanche power losses

$$P_{AR} = f(f)$$

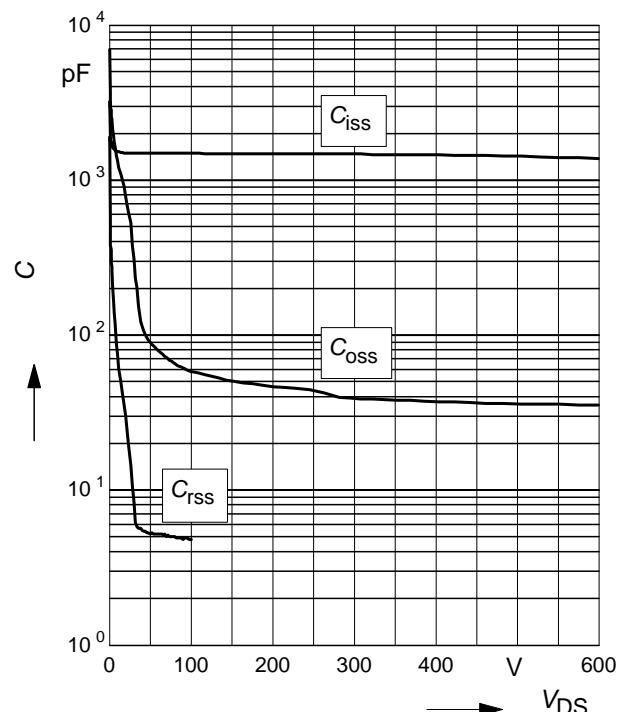
parameter: $E_{AR}=0.6 \text{ mJ}$



17 Typ. capacitances

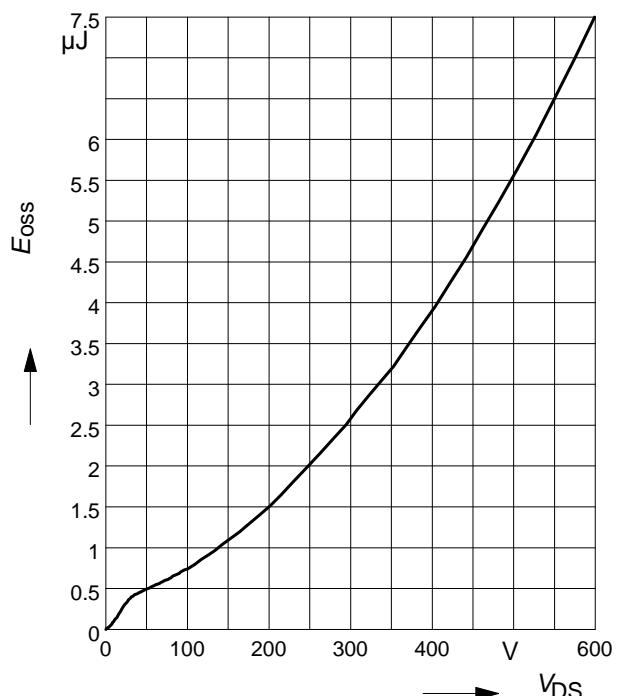
$$C = f(V_{DS})$$

parameter: $V_{GS}=0V$, $f=1$ MHz

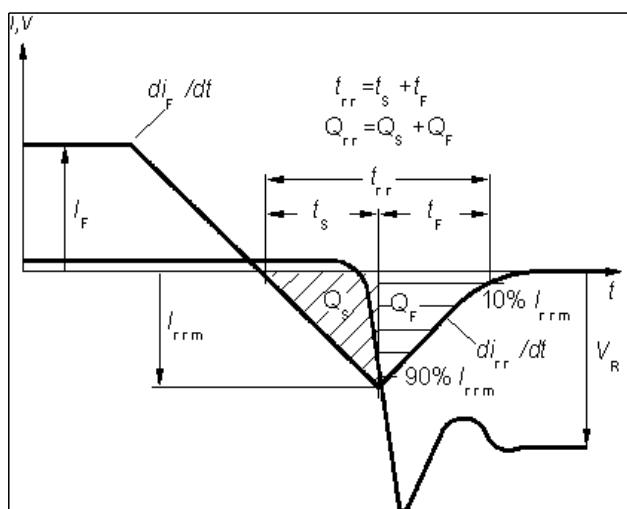


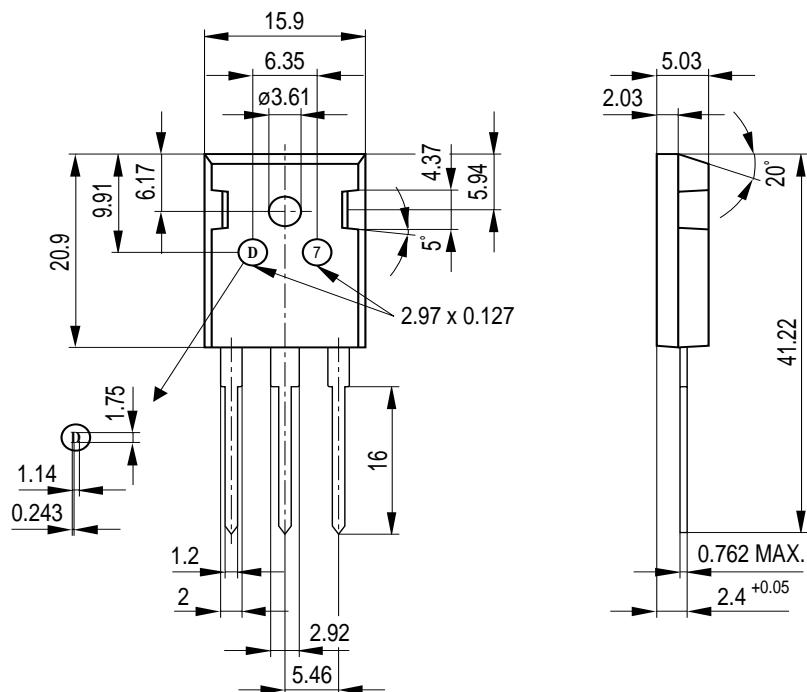
18 Typ. C_{oss} stored energy

$$E_{oss} = f(V_{DS})$$



Definition of diodes switching characteristics



P-TO-247-3-1


General tolerance unless otherwise specified:
 Leadframe parts: ± 0.05
 Package parts: ± 0.12

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